MOSFET – Power, Single, P-Channel, Trench, SC-88 -20 V, -4.2 A

NTJS4151P

Features

- Leading Trench Technology for Low R_{DS(ON)} Extending Battery Life
- SC-88 Small Outline (2x2 mm) for Maximum Circuit Board Utilization, Same as SC-70-6
- Gate Diodes for ESD Protection
- Pb-Free Package is Available

Applications

- High Side Load Switch
- Cell Phones, Computing, Digital Cameras, MP3s and PDAs

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Param	Symbol	Value	Unit		
Drain-to-Source Voltage	V_{DSS}	-20	V		
Gate-to-Source Voltage	V_{GS}	±12	V		
		T _A = 25 °C	I _D	-3.3	Α
Current (Note 1)	State	T _A = 85 °C		-2.4	
	t ≤ 5 s	T _A = 25 °C		-4.2	
Power Dissipation (Note 1)			P _D	1.0	W
Pulsed Drain Current	I _{DM}	-10	Α		
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to 150	°C
Source Current (Body Di	Is	-1.3	Α		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C
ESD Hum	an Body N	lodel (HBM)	ESD	4000	V

THERMAL RESISTANCE RATINGS (Note 1)

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State	$R_{\theta JA}$	125	°C/W
Junction–to–Ambient – t ≤ 5 s	$R_{\theta JA}$	75	
Junction-to-Lead - Steady State	$R_{ heta JL}$	45	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

 Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

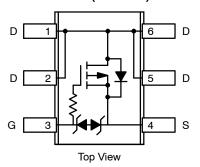


ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
	47 mΩ @ –4.5 V	
-20 V	70 mΩ @ -2.5 V	-4.2 A
	180 mΩ @ –1.8 V	

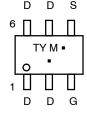
SC-88 (SOT-363)



MARKING DIAGRAM & PIN ASSIGNMENT



SC-88/SOT-363 CASE 419B



TY = Device Code

M = Date Code

Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information ion page 4 of this data sheet.

NTJS4151P

ELECTRICAL CHARACTERISTICS (T_J=25°C unless otherwise stated)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•			•		•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}		-20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	V _{GS} = 0 V, I _D = -250 μA		-12		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, T _J = 25°C			-1.0	μА
		$V_{DS} = 0 \text{ V},$ $V_{DS} = -16 \text{ V}$ $T_{J} = 85^{\circ}\text{C}$			-5.0	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±4.5 V			±1.5	μΑ
		V _{DS} = 0 V, V _{GS} = ±12 V			±10	mA
ON CHARACTERISTICS (Note 2)	•			ı		I
Gate Threshold Voltage	V _{GS(TH)}		-0.40		-1.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J	$V_{GS} = V_{DS}, I_D = -250 \mu A$		4.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -3.3 \text{ A}$		47	60	mΩ
		$V_{GS} = -2.5 \text{ V}, I_D = -2.3 \text{ A}$		70	85	
		$V_{GS} = -1.8 \text{ V}, I_D = -1.0 \text{ A}$		180	205	
Forward Transconductance	9 _{FS}	$V_{GS} = -10 \text{ V}, I_D = -3.3 \text{ A}$		12		S
CHARGES AND CAPACITANCES				•		ı
Input Capacitance	C _{ISS}			850		pF
Output Capacitance	Coss	$V_{GS} = 0 \text{ V, f} = 1.0 \text{ MHz,}$ $V_{DS} = -10 \text{ V}$		160		
Reverse Transfer Capacitance	C _{RSS}	VDS - 10 V		110		
Total Gate Charge	Q _{G(TOT)}			10		nC
Gate-to-Source Charge	Q _{GS}	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V},$ $I_{D} = -3.3 \text{ A}$		1.5		
Gate-to-Drain Charge	Q_GD	. ID = -0.0 A		2.8		
SWITCHING CHARACTERISTICS (Not	e 3)			ı		I
Turn-On Delay Time	t _{d(ON)}			0.85		μs
Rise Time	t _r	Vce = -4.5 V. Vnn = -10 V.		1.7		
Turn-Off Delay Time	t _{d(OFF)}	$V_{GS} = -4.5 \text{ V}, V_{DD} = -10 \text{ V},$ $I_{D} = -1.0 \text{ A}, R_{G} = 6.0 \Omega$		2.7		
Fall Time	t _f			4.2		
DRAIN-SOURCE DIODE CHARACTER	RISTICS					
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 \text{ V, } I_S = -1.3 \text{ A,}$ $T_J = 25^{\circ}\text{C}$		-0.75	-1.2	V
Reverse Recovery Time	t _{RR}			63		ns
Charge Time	Ta	$V_{GS} = 0 \text{ V, dI}_{S}/\text{dt} = 100$		9.0		
Discharge Time	T _b	- Α/μs, I _S = -1.3 Α		54		
Reverse Recovery Charge	Q _{RR}	1		0.23		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$. 3. Switching characteristics are independent of operating junction temperatures.

NTJS4151P

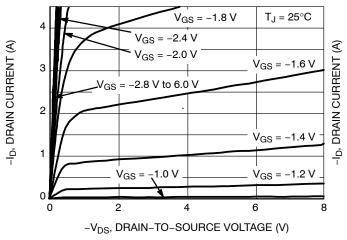
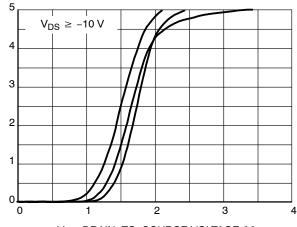


Figure 1. On-Region Characteristics



-V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

Figure 2. On-Region Characteristics

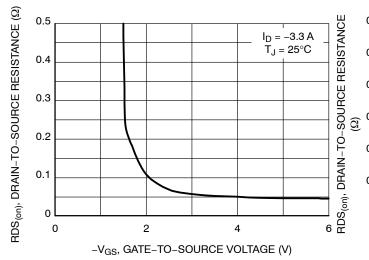


Figure 3. On-Resistance versus Gate-to-Source Voltage

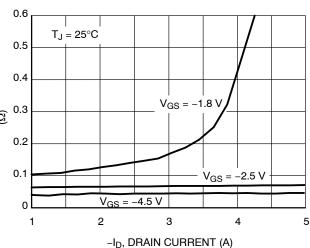
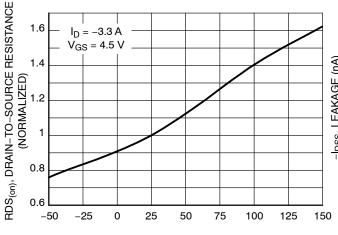


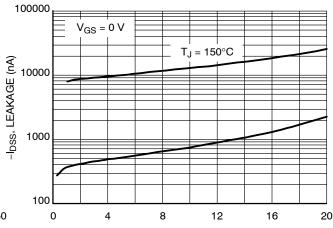
Figure 4. On-Resistance versus Drain Current and Gate Voltage



T_J, JUNCTION TEMPERATURE (°C)

Figure 5. On-Resistance Variation with

Temperature



-V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

Figure 6. Drain-to-Source Leakage Current versus Voltage

NTJS4151P

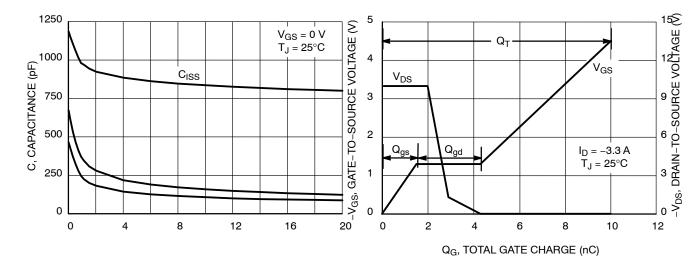


Figure 7. Capacitance Variation

Figure 8. Gate-to-Source and Drain-to-Source Voltage versus Total Charge

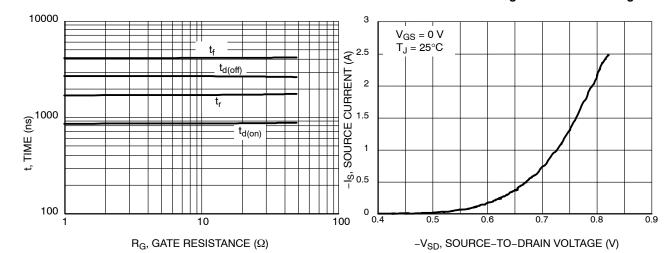


Figure 9. Resistive Switching Time Variation
Gate Resistance

Figure 10. Diode Forward Voltage versus Current

Table 1. ORDERING INFORMATION

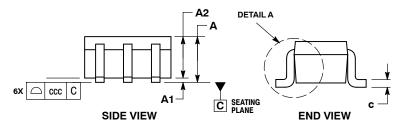
Part Number	Marking (XX)	Package	$Shipping^\dagger$
NTJS4151PT1	TY	SC-88	3000 / Tape & Reel
NTJS4151PT1G	TY	SC-88 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SC-88/SC70-6/SOT-363 CASE 419B-02 **ISSUE Y**

DATE 11 DEC 2012





NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS
- CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H. DATUMS A AND B ARE DETERMINED AT DATUM H. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.

- DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION 6 AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α			1.10			0.043
A1	0.00		0.10	0.000		0.004
A2	0.70	0.90	1.00	0.027	0.035	0.039
b	0.15	0.20	0.25	0.006	0.008	0.010
С	0.08	0.15	0.22	0.003	0.006	0.009
D	1.80	2.00	2.20	0.070	0.078	0.086
E	2.00	2.10	2.20	0.078	0.082	0.086
E1	1.15	1.25	1.35	0.045	0.049	0.053
е		0.65 BSC			.026 BS	С
L	0.26	0.36	0.46	0.010	0.014	0.018
L2	0.15 BSC 0.006 BSC				SC	
aaa	0.15				0.006	
bbb	0.30			0.012		
ccc	0.10			0.004		
ddd		0.10			0.004	

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

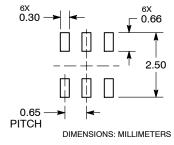
= Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

- *Date Code orientation and/or position may vary depending upon manufacturing location.
- *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13: PIN 1. ANODE 2. N/C 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 14: PIN 1. VREF 2. GND 3. GND 4. IOUT 5. VEN 6. VCC	STYLE 15: PIN 1. ANODE 1 2. ANODE 2 3. ANODE 3 4. CATHODE 3 5. CATHODE 2 6. CATHODE 1	STYLE 16: PIN 1. BASE 1 2. EMITTER 2 3. COLLECTOR 2 4. BASE 2 5. EMITTER 1 6. COLLECTOR 1	STYLE 17: PIN 1. BASE 1 2. EMITTER 1 3. COLLECTOR 2 4. BASE 2 5. EMITTER 2 6. COLLECTOR 1	STYLE 18: PIN 1. VIN1 2. VCC 3. VOUT2 4. VIN2 5. GND 6. VOUT1
STYLE 19: PIN 1. I OUT 2. GND 3. GND 4. V CC 5. V EN 6. V REF	STYLE 20: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR	STYLE 21: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. N/C 6. CATHODE 1	STYLE 22: PIN 1. D1 (i) 2. GND 3. D2 (i) 4. D2 (c) 5. VBUS 6. D1 (c)	STYLE 23: PIN 1. Vn 2. CH1 3. Vp 4. N/C 5. CH2 6. N/C	STYLE 24: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE
STYLE 25: PIN 1. BASE 1 2. CATHODE 3. COLLECTOR 2 4. BASE 2 5. EMITTER 6. COLLECTOR 1	STYLE 26: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1	STYLE 27: PIN 1. BASE 2 2. BASE 1 3. COLLECTOR 1 4. EMITTER 1 5. EMITTER 2 6. COLLECTOR 2	STYLE 28: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN	STYLE 29: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE/ANODE 6. CATHODE	STYLE 30: PIN 1. SOURCE 1 2. DRAIN 2 3. DRAIN 2 4. SOURCE 2 5. GATE 1 6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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